

#### Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- $\bullet$  Halogen-free
- RoHS compliant

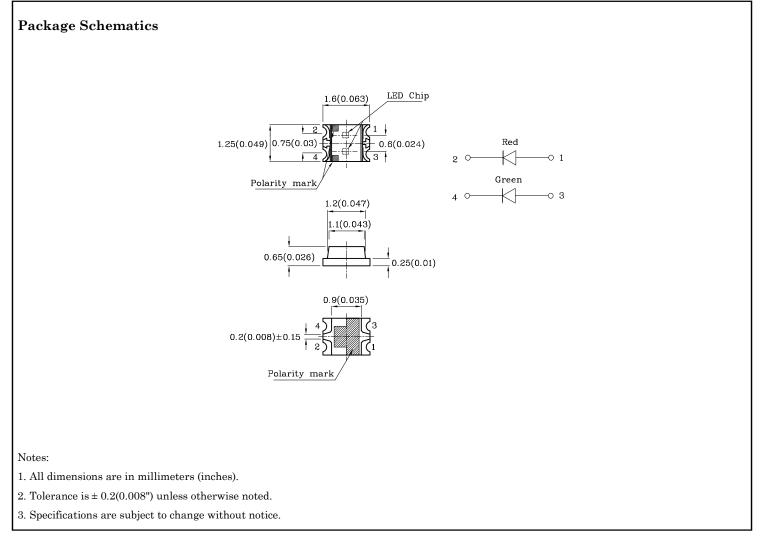




ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

# Applications

- Backlighting for tell-tale indicators
- $\bullet$  Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- Signs and signals
- Various applications requiring high temperature rating



Dec 13,2019



Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* (I <sub>F</sub> =5mA) mcd			Lens-color	Viewing Angle 20 1/2
			Code.	min.	max.		
			U	50	80		
	Red	AlGaInP	V	80	120	-	
	Kea	AlGainP	R*	15*	20*	-	
			S*	20*	30*	-	
		P 6 10		1 500			
XZMDKVG62W5MAV-1HTA			Q	10	15	Water Clear	150°
	Green	AlGaInP	R	15	20	- - -	
			P*	6*	10*		
			Q*	10*	15*		
			R*	$15^{*}$	20*		

Note:

1.01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

\*Luminous intensity value is in accordance with CIE127-2007 standards.

## Absolute Maximum Ratings at Ta=25°C

	G 1 1	Symbol Red		Unit	
Parameter	Symbol				
Power dissipation	PD	75	75	mW	
Reverse Voltage	VR	5	5	V	
Junction temperature	TJ	115	115	°C	
Operating Temperature	Тор	-40 Te	°C		
Storage Temperature	Tstg	-40 Te	°C		
DC Forward Current	$\mathbf{IF}$	30	30	mA	
Peak Forward Current [2]	IFM	185	185 150		
Electrostatic Discharge Threshold (HBM)		3000 3000		V	
Thermal Resistance (Junction/ambient) [1]	Rth j-a	650	780	°C/W	
Thermal Resistance (Junction / Solder point) [1]	$\operatorname{Rth}$ j-s	500	620	°C/W	

Notes:

1. Rth(j-a) Results from mounting on PC board FR4 (pad size  $\geq\!16$  mm² per pad),

2. 1/10 Duty Cycle, 0.1ms Pulse Width.

3. A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)



## Electrical / Optical Characteristics at Ta=25°C

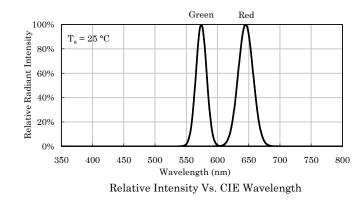
Parameter	S1 - 1	Chin		Va	Value		
Parameter	Symbol	Chip	Code.	Min.	Тур.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF = $5mA$	λpeak	Red Green	-	-	645* 574*		nm
		Red	-	620*	-	640*	
			4*	565*	-	567*	- nm
Dominant Wavelength CIE127-2007* IF = $5mA$	λdom [1]	Green	5*	567*	-	569*	
			6*	569*	-	571*	
Spectral bandwidth at 50% $\Phi$ REL MAX IF = 5mA	Δλ	Red Green	-	-	28 20	-	nm
Forward Voltage IF = 5mA	Vf [2]	Red Green	-	-	$1.8 \\ 1.95$	2.3 2.4	V
Reverse Current (VR = 5V)	IR	Red Green	-	-	-	10 10	μΑ
Temperature coefficient of $\lambda$ peak IF = 5mA, -10°C $\leq$ T $\leq$ 100°C	ТСдреак	Red Green	-	-	$\begin{array}{c} 0.14\\ 0.12\end{array}$	-	nm/°C
Temperature coefficient of $\lambda$ dom IF = 5mA, -10°C $\leq$ T $\leq$ 100°C	TCλdom	Red Green	-	-	$\begin{array}{c} 0.05\\ 0.08\end{array}$	-	nm/°C
Temperature coefficient of VF $IF = 5mA, -10^{\circ}C \le T \le 100^{\circ}C$	TCv	Red Green	-	-	-1.9 -1.9	-	mV/°C

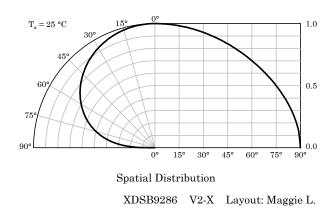
Notes:

1. Wavelength : + / -1nm.

2. Forward Voltage: +/-0.1V.  $\,$ 

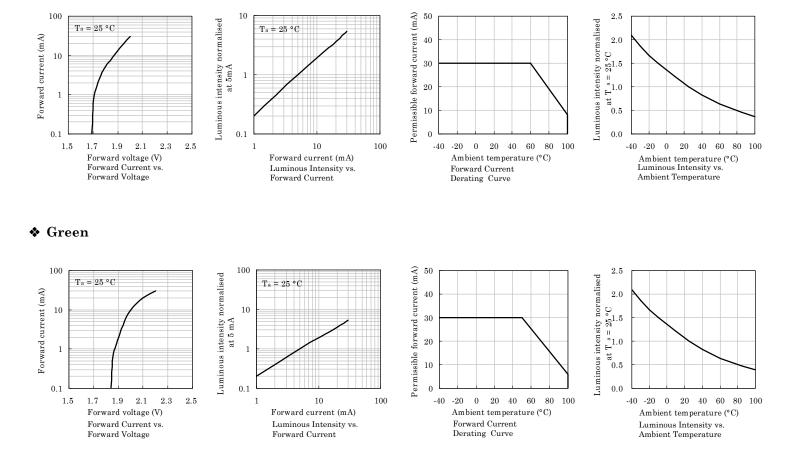
 $\ast$  Wavelength value is in accordance with CIE127-2007 standards.



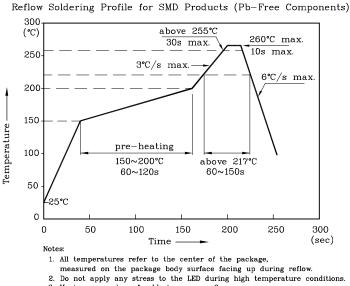




## ✤ Red



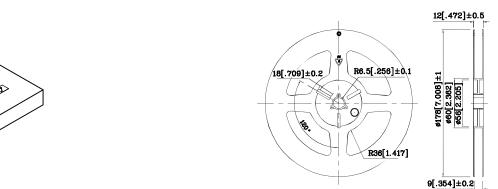
# LED is recommended for reflow soldering and soldering profile is shown below.



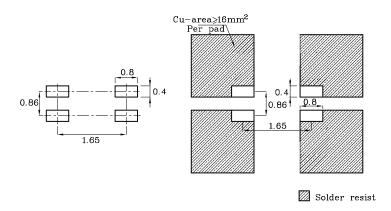


The device has a single mounting surface. The device must be mounted according to the specifications.

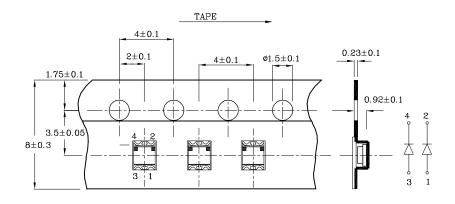
# Reel Dimension



Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Tape Specification (Units : mm)



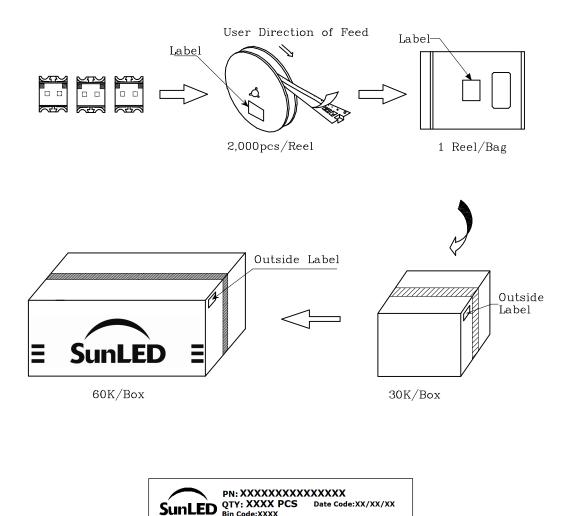
#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V  $\,$
- Note: Accuracy may depend on the sorting parameters.



# **PACKING & LABEL SPECIFICATIONS**



Q) QTY:XXXX

(33P) BIN CODE:XXXX

RoHS Compli Made in Chin

(9D) D/C:XXXX

#### TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.

(SP)XXXXXXXXXX

- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
- consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.

Lot Code

MFG PN:XXXXXXXXXXXXXXXXXX

(1P)

(4L) COO:CN

- 5. The contents within this document may not be altered without prior consent by SunLED.
- $6. \ Additional \ technical \ notes \ are \ available \ at \ \underline{https://www.SunLEDusa.com/TechnicalNotes.asp}$



# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below

## Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition		Number of Damaged
1	Continuous operating test	-	$T_a$ = 25°C, $I_F$ = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	$T_a$ = 100°C, $I_F$ = maximum rated current *	1,000 h	0 / 22
3	Low Temp. operating test	-	$T_a$ = -40°C, I <sub>F</sub> = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	$T_a$ = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	$T_a = -40^{\circ}C$	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100(103)	$T_a = 60^{\circ}C, RH = 90\%$	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100(102)	T <sub>a</sub> = 60°C, RH = 90% I <sub>F</sub> = maximum rated current *	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	$\begin{split} T_{a} &= -40^{\circ}C(15min) \sim 100^{\circ}C(15min) \\ I_{F} &= derated \ current \ at \ 100^{\circ}C \end{split}$	1,000 cycles	0 / 22
10	Thermal shock test	-	$T_a = -40^{\circ}C(15min) \sim maximum rated$ Storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	$C = 100 pF$ , $R2 = 1.5 K\Omega$ V = 3000V (Red) V=3000V (Green)	Once each Polarity	0 / 22
12	Vibration test	-	$a = 196 \text{m/s}^2$ , f = 100~2KHz, t = 48min for all xyz axes	4 times	0 / 22

\* : Refer to forward current vs. derating curve diagram

## **Criteria for Judging Damage**

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	IF = 5mA	Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value>
Forward Voltage	VF	IF = 5mA	Testing Max. Value ≥Spec.Max.Value x 1.2
Reverse Current	IR	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥Spec.Max.Value x 2.5
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking